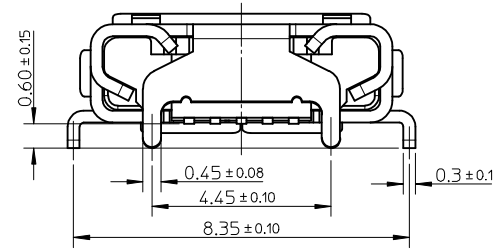
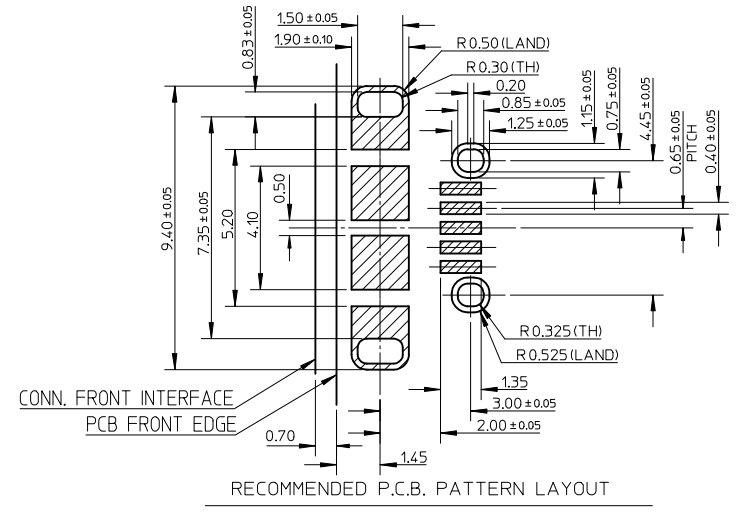


NOTE :

- MATERIAL :  
HOUSING : LCP, BLACK, UL94V-0  
TERMINAL : COPPER ALLOY THICKNESS = 0.15 MM  
SHIELD CASE : STAINLESS STEEL THICKNESS = 0.30 MM
- PLATING :  
TERMINAL : CONTACT AREA : GOLD FLASH (0.11 MICRON MIN.) OVER MINIMUM 0.75 MICRON Pd/Ni.  
SOLDER TAIL AREA : GOLD FLASH (0.05 MICRON MIN.).  
UNDER PLATING : NICKEL 2.0 MICROMN MINIMUM.  
SHIELD : MATTE TIN 1.27 MICRON MINIMUM.  
UNDER PLATING : NICKEL 1.27 MICRON MINIMUM.
- TAIL COPLANARITY 0.08 MM MAXIMUM.
- PRODUCT SPEC. : PS-47589-001, PACKING SEPC. : PK-47589-001
- COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC.



REVISE EC NO: SH2009-0126 DRWN: CWTANG CHKD: XJSONG APPR: HWANG	QUALITY SYMBOLS ▽=0 ∇=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY XJSONG	DATE 2007/03/06	TITLE MICRO USB AB REC. BOTTOM MOUNT ASS'Y			
		4 PLACES	± ---	± ---	CHECKED BY JTIAN	DATE 2007/03/06	MOLEX INCORPORATED			
		3 PLACES	± ---	± ---	APPROVED BY JNCHEN	DATE 2007/03/06				
2 PLACES	± 0.15	± ---	MATERIAL NO. 47589-0001		DOCUMENT NO. SD-47589-001		SHEET NO. 1 OF 1			
1 PLACE	± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					
ANGULAR ± 3 °										